

MS AMENDMENT PATENT 0171-0990P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

OSADA, Shoichi et al. Conf.:

Appl. No.:

10/617,827

Group:

1712

Filed:

July 14, 2003

Examiner: Zimmer, Marc S.

For:

SEMICONDUCTOR ENCAPSULATING EPOXY RESIN

COMPOSITION AND SEMICONDUCTOR DEVICE

LARGE ENTITY TRANSMITTAL FORM

MS AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 April 26, 2005

Transmitted herewith is an amendment in the above-identified application.

\sqcup	The enclosed document	is being	transmitted	via the	Certificate
	of Mailing provisions	of 37 C	.F.R. § 1.8.		

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The fee has been calculated as shown below:

	Claims Remaining After Amendment		HIGHEST NUMBER PREVIOUSLY PAID FOR		Present Extra	RATE	additional Pee
TOTAL	9	-	20	=	0	\$50	\$0.00
INDEPENDENT	1	-	3	=	0	\$200	\$0.00
FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM \$360 \$0.0							\$0.00
						TOTAL	\$0.00

	Petition for () mont 37 C.F.R. §§ 1.17 and 1.13 time.	h(s) extension of time pursuant to $86(a)$. \$0.00 for the extension of				
\boxtimes	No fee is required.					
	Check(s) in the amount of \$0.00 is(are) enclosed.					
	Please charge Deposit Acco	ount No. $02-2448$ in the amount of ted in triplicate.				
over requ	current, and future replies, rpayment to Deposit Account Nuired under 37 C.F.R. § 1 ticularly, extension of time					
	Res	spectfully submitted,				
	BIR	CH, STEWART, KOLASCH & BIRCH, LLP				
	/KJR:bmp Fal	H M Murphy, Jr., #28,977 D. Box 747 Cls Church, VA 22040-0747 (3) 205-8000				

Attachment(s)